Improvement of surface and interface roughness estimation on X-ray reflectivity

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In the conventional X-ray reflectivity (XRR) analysis, the reflectivity is calculated based on the Parratt formalism, incorporating the effect of the interface roughness according to Nevot and Croce. However, the results of calculations of the XRR have shown strange outcomes, where interference effects increase at a rough surface because of a lack of consideration of diffuse scattering within the Parratt formalism. Therefore, we have developed a new improved formalism in which the effects of the surface and interface roughness are included correctly. In this study, for deriving a more accurate formalism of XRR, we tried to compare the measurements of surface roughness of the same sample by atomic force microscopy (AFM) and XRR. It is found that the AFM result could not be completely reproduced even with the improved XRR formalism. By careful study of the AFM results, we determined the need for an additional effective roughness term within the XRR simulation that depends on the angle of incidence of the beam. © 2014 International Centre for Diffraction Data. [doi:10.1017/S0885715614000359]

Key words: X-ray reflectivity, surface roughness, surface and interfaces, AFM observation.

I. INTRODUCTION

Characterization of the interface in multilayer structures is of prime importance in many applications, such as microelectronics. X-ray reflectometry is often used for the estimation of the surface and interface roughness as well as the thickness of each layer (Parratt, 1954; Nevot and Croce, 1980; Sinha et al., 1988; Holy et al., 1993; Daillant and Gibaud, 1999; Fujii et al., 2004, 2005; Fujii, 2010, 2011, 2013). In the X-ray reflectivity (XRR) analysis, the reflectivity is usually calculated based on the Parratt formalism (Parratt, 1954), coupled with the use of the theory of Nevot and Croce to include the effect of surface and interface roughness (Nevot and Croce, 1980). However, XRR simulations that are calculated in this way sometimes show strange results. The calculated amplitude of the oscillation, which originates from the interference effects, increases with increasing surface roughness in some cases. This strange behavior suggests that the method used to incorporate the effect of surface and interface roughness into the Parratt formalism is not adequate. Actually, we have recently demonstrated that the diffuse scattering at the interface is not correctly taken into account in the conventional formula (Fujii, 2010, 2011, 2013). For precise measurements, correction of the conventional formula is required. In order to derive a more accurate formalism of XRR, we measured the surface roughness of the same sample by atomic force microscopy (AFM) and XRR, and compared the results of the measurements.

II. EXPERIMENTAL AND RESULTS

A. Sample preparation

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Two samples of silicon wafers having a thin SiO_2 layer were prepared by the following methods. Sample A was

prepared by thermal oxidizing of a Si(001) wafer. The thickness of the prepared SiO₂ layer is about 5 nm. Sample B was prepared by vacuum deposition of an additional SiO₂ layer of about 2 nm onto sample A at room temperature. The roughness of the SiO₂/Si interface for sample B is expected to be the same as sample A although the surface roughness should be increased after the deposition. The surfaces of these samples were measured by XRR and AFM.

B. XRR measurement

XRR measurements were performed using a CuK α l X-ray beam from a 3 kW rotating-anode source. The beam size of the X-ray was about 2 mm (perpendicular to the reflection plane) × 0.05 mm (parallel to the reflection plane). The XRR results measured for samples A and B are shown as a function of the angle of incidence, θ_i , by dashed curves in Figures 1(a) and 1(b), respectively. For θ_i values smaller than the critical angle for total reflection (i.e. 0.22°), the reflectivity is almost unity. With increasing θ_i over the critical angle, the reflectivity decreases and oscillatory structures are seen. These oscillations originate from the interference of X-rays reflected from the surface and the interface of the SiO₂/Si. By analyzing the θ_i -dependence of the reflectivity, the surface roughness, interface roughness, and the thickness of the SiO₂ layer can be estimated.

C. AFM observation

The surfaces of samples A and B were observed by AFM. Figures 2(a) and 2(b) show the AFM images and the roughness profiles of samples A and B, respectively. The r.m.s. surface roughness (σ_s) at the area of $1 \times 1 \,\mu\text{m}^2$ of the SiO₂ surfaces of samples A and B in Figures 2(a) and 2(b) were both about 0.17 nm, and those over an area of $10 \times 10 \,\mu\text{m}^2$ in Figures 2(c) and 2(d) were both about 0.24 nm. AFM

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Figure 1. (Color online) (a) XRR from sample A. The experimental result (thick dashed curve) is compared with the calculated ones for $\sigma_i = 0.42$ nm and various σ_s (thin curves). (b) XRR from sample B. The experimental result (thick dashed curve) is compared with the calculated ones for $\sigma_i = 0.42$ nm and various σ_s (thin curves).



Figure 2. (Color online) (a) AFM image and the roughness profile of sample A (in the area of $1 \mu m^2$). (b) AFM image and the roughness profile of sample B (in the area of $1 \mu m^2$). (c) AFM image and the roughness profile of sample A (in the area of $10 \mu m^2$). (d) AFM image and the roughness profile of sample B (in the area of $10 \mu m^2$). (d) AFM image and the roughness profile of sample B (in the area of $10 \mu m^2$).

observation shows that changes in surface roughness before and after vapor deposition of SiO_2 were negligible.

III. DISCUSSION

In the conventional XRR analysis, the reflectivity is calculated based on the Parratt formalism (Parratt, 1954), incorporating the effect of the interface roughness according to the theory of Nevot and Croce (1980). Recently, we have found that, in some cases the surface and interfacial roughness derived using this conventional formula are not consistent with those measured by transmission electron microscope (TEM) (Fujii, 2010, 2011). We also found that, in some cases the conventional formula gives strange results when the interface roughness increases, i.e. the amplitude of the oscillation becomes larger with increasing interface roughness (Fujii, 2010, 2011, 2013). This is strange because the interference of X-rays reflected from the surface and interface should be weaker with increasing roughness. These results were attributed to the fact that the diffuse scattering at the rough interface was not correctly taken into account in the conventional formula by Nevot and Croce. Therefore, we have developed a new formula in which the effects of the surface and interface roughness are correctly treated (Fujii, 2010, 2011, 2013). The XRR R of a multilayer sample consisting of N layers is given by:

$$R = |R_{0,1}|^2,$$

$$R_{j-1,j} = \frac{\Psi_{j-1,j} + (\Phi_{j-1,j}\Phi_{j,j-1} - \Psi_{j-1,j}\Psi_{j,j-1})R_{j,j+1}}{1 - \Psi_{j,j-1}R_{j,j+1}} \times \exp(2ik_{j-1,z}h_{j-1}), R_{N,N+1} = 0$$
(1)

where $R_{j-1,j}$ is the reflection coefficient at the interface between *j*-1th layer and *j*th layer, h_j is the thickness of the *j*th layer, $h_0 = 0$, $k_{j,z}$ is the *z* component of the wave vector in the *j*th layer, and $\Psi_{j-1,j}$ and $\Phi_{j-1,j}$ are the Fresnel coefficients for reflection and refraction, respectively, at the interface between the (j-1) th layer and the *j*th layer. Although the formula for $\Psi_{j-1,j}$ is well known:

$$\Psi_{j-1,j} = \frac{k_{j-1,z} - k_{j,z}}{k_{j-1,z} + k_{j,z}} \exp\left(-2k_{j-1,z}k_{j,z}\sigma_{j-1,j}^2\right),$$

$$\Psi_{j,j-1} = -\Psi_{j-1,j}$$
(2)

where $\sigma_{j-1, j}$ is the interface roughness between (j-1) th and *j*th layers, an accurate analytical formula for $\Phi_{j-1, j}$ including the effect of the interface roughness is not available. There are several approximations proposed for $\Phi_{j-1, j}$ and all these results can be written as:

$$\Phi_{j-1,j} = \frac{2k_{j-1,z}}{k_{j-1,z} + k_{j,z}} \exp\left\{-\left[C_1(k_{j-1,z} - k_{j,z})^2 + C_2k_{j-1,z}k_{j,z}\right]\sigma_{j-1,j}^2\right\}, \quad \Phi_{j,j-1} = \Phi_{j-1,j}\frac{k_{j,z}}{k_{j-1,z}} \quad (3)$$

where parameters C_1 , C_2 depend on the proposed approximation (Vidal and Vincent, 1984; Sinha *et al.*, 1988; Holy *et al.*, 1993, 1999; Boer, 1995; Daillant and Gibaud, 1999; Fujii *et al.*, 2004, 2005; Sakurai, 2009; Fujii, 2010, 2011, 2013). In the present work, we choose $C_1 = 1$ and $C_2 = 0$,

which, we believe, is the most appropriate approximation (Fujii, 2010, 2011, 2013).

As was mentioned above, the origin of the oscillation is the interference between the X-rays reflected from the surface and the interface. Thus the thickness of the SiO_2 layer can be determined from the observed period of the oscillation. The degree of the decrease in the XRR for angles larger than the total reflection critical angle is strongly related to the surface roughness. The detailed procedure to derive the layer thickness from the observed period of the oscillation can be found in the literature (Parratt, 1954).

After analyzing the XRR results with the above procedure, the SiO₂ layer profiles of sample A were derived. The thickness of the SiO₂ layer was determined to be 5.3 nm. Using Eqs (1) and (3), the reflectivity was calculated with various values of surface roughness σ_s , where the sample was treated as three layers (vacuum/SiO₂/Si). The calculated results are compared with the experimental one in Figure 1(a).

When σ_s is increased the calculated reflectivity decreases more rapidly with θ_i . This indicates that the surface roughness can be accurately determined by comparing the θ_i -dependence of the calculated results with the experimental one. The best fit was obtained using a surface roughness of 0.52 nm. We also modeled the interface roughness by fitting the calculated reflectivity to the observed reflectivity. The best fit was obtained using an interface roughness value of 0.42 nm for sample A.

The calculated reflectivity for a surface roughness of $\sigma_s = 0.52$ nm and interface roughness of $\sigma_i = 0.42$ nm is shown by a solid line in Figure 1(a). The agreement with the experimental result is very good. It should be noted that we cannot obtain good agreement if we use other values for C_1 and C_2 , such as $(C_1, C_2) = (0.5, 0)$, (-0.5, 0), proposed in the literatures (Holy *et al.*, 1993, 1999; Boer, 1995; Daillant and Gibaud, 1999; Fujii, 2010, 2011). Our analysis indicates that $(C_1, C_2) = (1, 0)$ is the most reliable among the proposed values.

A similar procedure was applied to analyze the XRR data of sample B. From the period of the oscillation, the thickness of the SiO_2 layer was determined to be 7.8 nm. Using Eqs. (1)-(3), the reflectivity was calculated with various values of σ_s . Some examples of the calculated results are compared with the experimental one in Figure 1(b). Because the deposition of the additional SiO₂ layer of 2 nm does not change the interface roughness, we used the interface roughness determined for the sample A ($\sigma_i = 0.42$ nm) in the estimation of the surface roughness of the sample B. Using these values (σ_i = 0.42 nm and the thickness 7.8 nm), the reflectivity was calculated for various values of surface roughness σ_s . Figure 1(b) shows the comparison between the calculated and experimental results. In contrast to sample A, none of the calculated results can reproduce the experimental one. At $\theta_i > 1.0^\circ$ the calculated result for $\sigma_s = 0.54$ nm agrees with the experimental one, while the calculated result deviates from the experimental one at smaller θ_i . Conversely, the calculated result for $\sigma_s =$ 1.08 nm agrees with the experimental one at smaller θ_i , but it deviates seriously at higher θ_i . A possible explanation of the present discrepancy may be that the effective surface roughness measured by XRR depends on the size of the effective probing area on the surface, which is proportional to $1/\sin\theta_i$. In general, the surface roughness increases with increasing size of the probing area. As a result, the effective roughness observed at smaller θ_i is larger than that at larger θ_i in accordance with the present result. Such a θ_i -dependence of the effective roughness in XRR has been usually neglected. The present result, however, indicates that it should be taken into account in cases such as sample B, of which the effective roughness depends on the size of the probing area.

Assuming the effective roughness is mainly dictated by refraction Fresnel coefficients, we can account for the incident angle dependence of roughness in XRR simulation via the following new formula for $\Phi_{j-1, j}$ as,

$$\Phi_{j-1,j} = \frac{2k_{j-1,z}}{k_{j-1,z} + k_{j,z}} \exp\left\{-\left[C_1(\theta_i)(k_{j-1,z} - k_{j,z})^2 + C_2(\theta_i)k_{j-1,z}k_{j,z}\right]\sigma_{0,1}^2\right\}, \Phi_{j,j-1} = \Phi_{j-1,j}\frac{k_{j,z}}{k_{j-1,z}}$$
(4)

where the parameters $C_1(\theta_i)$, $C_2(\theta_i)$ depend on the incident angle θ_i and play the role of effective parameters for the effective roughness term depending on the incident angle. We typically derive $C_1(\theta_i)$, $C_2(\theta_i)$ via fitting of experimental results. However, the value of the parameter C_1 , C_2 may depend on the structure of the two planes that both run parallel to the surface but which bisect the surface roughness and the interface roughness variability, respectively. More analysis is needed to fully elucidate the details of this new model and its parameters.

From AFM observations, the surface roughness σ_s of the SiO₂ surfaces of both samples A and B was estimated as 0.17 nm at the area of $1 \times 1 \ \mu\text{m}^2$ and 0.24 nm at the area of 10×10 μ m². These results are different from the XRR analysis. The surface roughness values estimated from AFM observation show smaller values than those of XRR. Likewise, surface roughness σ_s are smaller for a probe area of $1 \times 1 \,\mu\text{m}^2$ than for the area of $10 \times 10 \,\mu\text{m}^2$. This suggests that the value of determined roughness depends on the size of the area probed and may be different in the XRR measurements. In XRR measurements, the area probed changes with incidence angle. The footprint is large at low angles of incidence, thereby probing a larger area of sample. The area probed shrinks quickly as the incidence angle is raised. The angular dependence of surface roughness because of probe dimensions is a concept that has perhaps been overlooked in modeling of reflectivity data.

IV. CONCLUSION

The surface and interface roughness of SiO₂/Si(001) were measured using XRR and AFM. In a new improved XRR formalism, we could not reproduce the observed reflectivity using a constant roughness value that is invariant of the incident angle. AFM results suggested the need of the introduction of the effective roughness term that depends on the incident angle for XRR calculation, thus demonstrating that effective roughness depends on the size of the probing area. This should be taken into account for precise XRR analysis. And it is thought that the value of the parameters C_1 , C_2 of refraction Fresnel coefficients depends on the structure of a parallel direction on the surface roughness and the interface roughness. Therefore, the investigation about many samples will be necessary in future. We will continue to refine this theory.

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